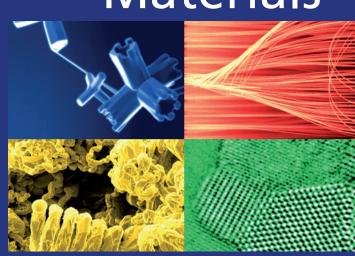




1st Announcement

Intelligent Materials



25-27 Sept 2013

Kiel Germany



Deutsche Gesellschaft für Materialkunde eV

Scope

Intelligent materials with integrated functionalities are required to make devices more energy efficient, autonomous, self-responding, switchable, biocompatible, and anti-bacterial. They are also integrated into novel sensor and actuator devices with significantly increased sensitivity. Such intelligent materials typically have a complex internal structure: they can be composites from different material classes like multiferroics. They might be nanostructured or hierarchically built-up, they could be bio-inspired and possess functional elements ranging from single molecules to the macro-scale. All those materials and their design and development has to be accompanied by high-resolution analytical tools that are able to characterize the materials on all scales and. moreover, to track and reveal their function-structure relations in situ.

The symposium will bring together experts in the field of intelligent materials in order to present and discuss recent developments and detect future trends.

The symposium will be a forum to get in contact with international key researchers and stimulate new collaborations for developing novel intelligent material systems, characterizing their functionality from molecular mechanisms to applications.

Eckhard Quandt Christian-Albrechts University of Kiel, Germany

Topics

- Multiferroics
- Smart materials
- Composites
- · Bio-inspired materials
- Medical applications
- Biofunctional materials
- Switchable surfaces / properties
- Advanced characterization techniques

Call for Abstracts

The organisers invite prospective authors to submit an abstract relating to the conference topics. Abstracts should not exceed 300 words in length and should be submitted through the conference website.

The abstracts will be evaluated, and if accepted, the authors will be informed about the kind of presentation (oral or poster). Especially young scientists are very welcome to actively contribute to the conference by submitting an abstract.

Programme Committee



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Joachim Wecker Siemens AG, Erlangen



Manfred Wuttig University of Maryland, USA



General Information

Location

The symposium will take place in Kiel, which is a pleasant town located at the coast of the Baltic Sea. The hotel Maritim is situated in one of the nicest areas of Kiel, in the middle of Düsternbrook forest, and within walking distance from the waterfront. Due to its nice location and several inside and outside refreshment opportunities, it offers a stimulating atmosphere that facilitates social interaction also beyond the technical programme.

Key Dates and Deadlines:

Submission of Abstracts 28 Feb 2013 Notice to Authors March 2013 Publication of Programme May 2013

Conference and Exhibition Secretariat

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Proceedings

The papers presented at the conference can be published in a special edition of **Advanced Engineering Materials**. Detailed instruction for the authors will be available on the conference website.